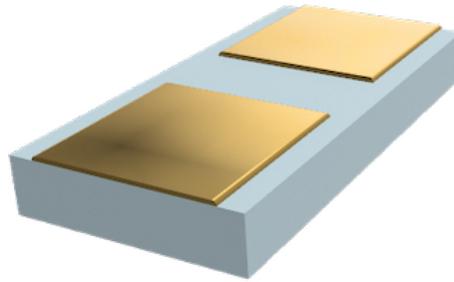


Gap Capacitor

XG2



Product Overview

Eulex single layer SMD mount gap capacitor with (Pt or Au) metallization for solder, or epoxy die attach.

Part Numbering System

XG1	A	15	N	100	K	P	W
Eulex Gap	Rated Voltage	Case Size	Dielectric Type	Capacitance	Capacitance Tolerance	Metallization Type	Packaging

Dielectrics and Voltage Rating

Dielectric Type		Dielectric Characteristics				Voltage Code	
		Temp Coeff	Tolerance	Temp Range	Metallization		
P	Porcelain	Neg.	B, C, D [G, J >10pF]	-55 to 125°C	Au/Pt	A	6.3VDC
Q	Class I/NPQ	±25ppm	B, C, D [G, J >10pF]	-55 to 125°C	Au/Pt	C	10VDC
N	Class I/NP0	±30ppm	J, K, M	-55 to 125°C	Au/Pt	E	16VDC
C	Class I/NPS	+0-5%	J, K, M	-55 to 125°C	Au/Pt	L	25VDC
X	Class II/X7R	±15%	K, M, P	-55 to 125°C	Au/Pt	G	50VDC
Y	Class III/Y5V	+22%-82%	M, P, Z	-30 to 85°C	Pt	B	100VDC

Tolerance Code									
Code	B	C	D	G	J	K	M	P	Z
Tolerance	±0.10 pF	±0.25 pF	±0.50 pF	±2%	±5%	±10%	±20%	+100 / -0%	+80 / -20%

Termination Material (P/G)

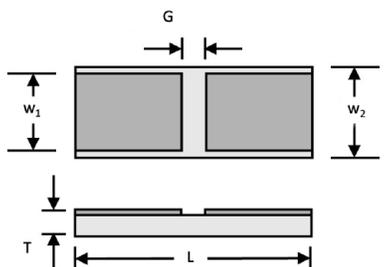
Metallization
Pt 100µin min
Au 100µin min

Packaging (G/W/T)

Package Type	Pack Qty
Gel-Pak/Waffle / Tape and Reel	N/A

Case Size & Dimensions

XG	Case Size	Length (L) Inch (mm)	Chip Width (W2) Inch (mm)	Thickness (T) Inch (mm)	Pad Width (W1) Inch (mm)	Gap (G) Inch (mm)
50	0806	0.080 ±0.004 (2.032 ±0.102)	0.060 ±0.004 (1.651 ±0.102)	0.014 Max (0.356 Max)	0.0048 ±0.003 (0.122 ±0.076)	0.008 Min (0.203 Min)
40	0805	0.080 ±0.004 (2.032 ±0.102)	0.050 ±0.004 (1.270 ±0.102)	0.014 Max (0.356 Max)	0.040 ±0.003 (1.016 ±0.076)	0.008 Min (0.203 Min)
25	0803	0.080 ±0.004 (2.032 ±0.102)	0.030 ±0.003 (0.762 ±0.076)	0.012 Max (0.305 Max)	0.025 ±0.003 (0.635 ±0.076)	0.004 Min (0.102 Min)
22	0603	0.060 ±0.004 (1.524 ±0.102)	0.030 ±0.003 (0.762 ±0.076)	0.012 Max (0.305 Max)	0.024 ±0.003 (0.610 ±0.076)	0.003 Min (0.076 Min)
20	0503	0.045 ±0.004 1.143 ±0.102	0.025 ±0.003 (0.635 ±0.076)	0.012 Max (0.305 Max)	0.021 ±0.003 (0.533 ±0.076)	0.003 Min (0.076 Min)
15	0402	0.040 ±0.004 (1.016 ±0.102)	0.020 ±0.002 (0.508 ±0.051)	0.009 Max (0.229 Max)	0.017 ±0.003 (0.432 ±0.076)	0.003 Min (0.076 Min)
12	0301	0.035 ±0.005 (0.889 ±0.127)	0.012 Max (0.305 Max)	0.009 Max (0.229 Max)	0.008 ±0.003 (0.203 ±0.076)	0.003 Min (0.076 Min)
10	0201	0.020 ±0.004 (0.508 ±0.102)	0.012 Max (0.305 Max)	0.009 Max (0.229 Max)	0.007 ±0.002 (0.178 ±0.051)	0.002 Min (0.051 Min)



Dimensions

Capacitance Rating

6.3V	50	40	25	22	20	15	12	10
Dielectric	Cap (pF)							
P	22	15	11	7.5	4.7	3.6	1.8	0.5
Q	43	30	18	15	8.2	6.2	3.3	0.8
N	120	88	56	43	27	18	10	2.4
C	470	360	220	180	100	75	41	10
X	3000	2200	1300	1000	620	430	240	62
Y	18000	13000	8200	5900	3900	2700	1500	360

10V	50	40	25	22	20	15	12	10
	Cap (pF)							
P	18	12	7.5	5.6	3.6	2.7	1.5	0.4
Q	30	22	15	10	6.8	4.8	2.7	0.6
N	91	68	43	30	20	15	7.5	2.0
C	360	270	180	120	75	56	30	7.5
X	2200	1600	910	750	47	330	180	47
Y	13000	9100	5600	4700	2700	2200	1100	270

Capacitance Rating

16V	50	40	25	22	20	15	12	10
Dielectric	Cap (pF)							
P	15	10	6.2	4.7	3.0	2.2	1.2	0.3
Q	24	18	10	8.2	5.1	3.9	2.2	0.5
N	73	51	33	24	15	12	6.2	1.5
C	270	220	120	100	62	47	24	6.2
X	1800	1200	750	600	360	270	150	36
Y	10000	7500	4700	3600	2200	1600	880	220

25V	50	40	25	22	20	15	12	10
Dielectric	Cap (pF)							
P	12	8.2	5.1	4.0	2.4	2.0	1.0	0.25
Q	20	15	9.1	6.8	4.3	3.3	1.8	0.4
N	62	45	27	20	12	10	5.1	1.2
C	240	180	110	82	51	40	20	5.1
X	1500	1100	680	510	300	220	120	30
Y	9100	6500	4000	3000	2000	1500	750	180

50V	50	40	25	22	20	15	12	10
Dielectric	Cap (pF)							
P	11	8.0	4.7	3.6	2.4	1.8	0.9	0.2
Q	19	13	8.5	6.2	4.0	3.0	1.5	0.3
N	56	43	27	20	12	9.1	4.7	1.2
C	220	160	100	75	47	36	19	4.7
X	1400	1000	600	470	290	200	110	30
Y	8200	6000	3600	2700	1800	1300	680	180

100V	50	40	25	22	20	15	12	10
Dielectric	Cap (pF)							
P	10	7.2	4.4	3.3	2.1	1.6	0.8	0.1
Q	16	12	7.5	5.6	3.6	2.7	1.4	0.2
N	51	36	23	17	11	8.2	4.3	1.1
C	200	150	90	70	43	33	17	4.4
X	1200	900	560	430	270	180	100	25
Y	7500	5500	3300	2500	1600	1200	620	150

Test Conditions

No.	Item	Test Condition	Requirements
1	Visual & Dimensions	Suitable optical or mechanical measurement system	<ul style="list-style-type: none"> No major defects Conforms to individual specification sheet"
2	Capacitance	<ul style="list-style-type: none"> Measured at 1.0±0.2Vrms, 1.0MHz±10% Measured at room temperature" 	<ul style="list-style-type: none"> Shall not exceed specified capacitance plus allowed tolerance.
3	Dielectric Strength	<ul style="list-style-type: none"> 250% of rated voltage. Duration: 1 to 5 sec. Charge & discharge current <50mA." 	<ul style="list-style-type: none"> No evidence of damage or arc-over during test.
4	Insulation Resistance	<ul style="list-style-type: none"> Time rated voltage applied for 120 secs Max Test at room temperature" 	<ul style="list-style-type: none"> ≥100GΩ minimum
5	Temperature Coefficient	<ul style="list-style-type: none"> No electrical load Allow temperature to equilibrate prior to measure" 	<ul style="list-style-type: none"> Capacitance change ±30ppm between -55 to +125°C from reference measurement at 20°C.
6	Termination Strength	<ul style="list-style-type: none"> MIL-STD-883, device mounted to Au metalized alumina substrate with Au-Sn20. Apply force parallel to substrate until failure. 	<ul style="list-style-type: none"> Die bond strength 2N min.
7	High Temperature Load	<ul style="list-style-type: none"> Test temp.: 125±3°C Applied voltage: Rated Volt Test time: 1000+24/-0 hrs. Cap. / DF / I.R. Measurement to be made after de-aging at 150°C for 1hr then 24±2hr age at RT 	<ul style="list-style-type: none"> No major damage Cap change: within ±7.5% or ±0.75pF whichever is larger I.R. ≥1GΩ

Packaging Details

Dimensions (mm)					
A	B	P	W	L	T
Samples Provided in Gel-Pak AD-22T-00X8					

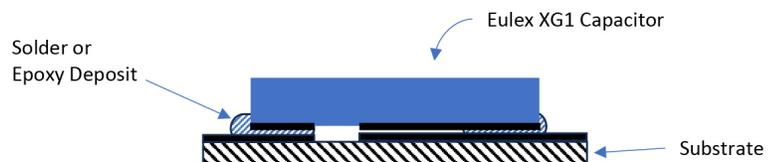
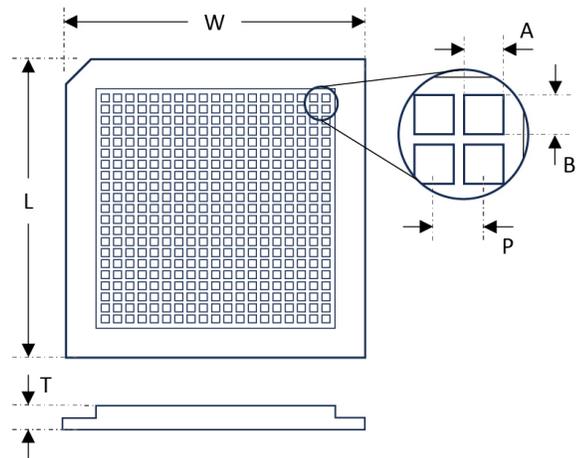
Mounting Methods

Solder Attach

Parts are mounted terminations down.
 Solder compositions suitable for Au attachment are acceptable.
 Au-Sn20 or In-Pb30 solder is recommended.
 Do not exceed 320°C.
 Heating cycle to remain below 5°C/sec and cooling below 4°C/sec.

Epoxy Bonding

Parts are suitable for conductive epoxy bonding.
 Epoxy should be deposited towards edge of part, taking care not to short gap between terminals.



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